

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of Invention

FORMATION OF PROTECTION LAYER BY DRIPPING DI ON WAFER WITH HIGH ROTATION TO PREVENT STAIN FORMATION FROM H2O2/H2SO4 CHEMICAL SPLASH

Application Number:

10/826487

Confirmation Number:

1358

First Named Applicant:

BO ZHENG

Attorney Docket Number: AMAT7589
Search string: (4557785 c

(4557785 or 5022419 or 5095027 or 5154199

or 5221360 or 5409310 or 6062239 or 6167893 or 6199298 or 6217667 or 6240933 or 6286231 or 6309981 or 6318385 or 6319841 or 6333275 or 6350319 or 6357142 or 6401732 or 6413436 or 6446643 or 6446644 or 6537416 or 6550484

or 6558478 or 6615854 or 20020026729).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

	init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	A	1	4557785	1985-12-10	OHKUMA			
	7	2	5022419	1991-06-11	THOMPSON, ET AL.			
		3	5095027	1992-03-10	GOLDBERG, ET AL.			
		4	5154199	1992-10-13	THOMPSON, ET AL.			
		5	5221360	1993-06-22	THOMPSON, ET AL.			
		6	5409310	1995-04-25	OWCZARZ			
		7	6062239	2000-05-16	BEXTEN			
		8	6167893	2001-01-02	TAATJES, ET AL.			
		9	6199298	2001-03-13	BERGMAN			
		10	6217667	2001-04-17	JOLLEY	ľ		
		11	6240933	2001-06-05	BERGMAN			
	Ш	12	6286231	2001-09-11	BERGMAN, ET AL.			
4	$I_{\mathcal{I}}$	13	6309981	2001-10-30	MAYER, ET AL.			
		14	6318385	2001-11-20	CURTIS, ET AL.			

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	15	6319841	2001-11-20	BERGMAN, ET AL.
1	16	6333275	2001-12-25	MAYER, ET AL.
	17	6350319	2002-02-26	CURTIS, ET AL.
	18	6357142	2002-03-19	BERGMAN, ET AL.
	19	6401732	2002-06-11	BERGMAN
	20	6413436	2002-07-02	AEGERTER, ET AL.
	21	6446643	2002-09-10	CURTIS, ET AL.
	22	6446644	2002-09-10	DOLECHEK
	23	6537416	2003-03-25	MAYER, ET AL.
	24	6550484	2003-04-22	GOPINATH, ET AL.
	25	6558478	2003-05-06	KATAKABE, ET AL.
	26	6615854	2003-09-09	HONGO, ET AL.

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
11.	1	20020026729	2002-03-07	BERGMAN, ET AL.			

Ŕemarks

Note: Remarks are not for responding to an office action.

NO FEES DUE - FILED BEFORE 1ST OA

Signature

/Examiner Name	Date
	2/14/06

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